COMPLIANT

HALOGEN

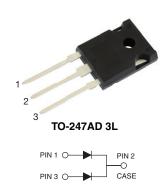
FREE



### Vishay General Semiconductor

# Dual High-Voltage TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.47 \text{ V}$  at  $I_F = 5.0 \text{ A}$ 



| PRIMARY CHARACTERISTICS                               |                |  |  |  |  |
|---|----------------|--|--|--|--|
| I <sub>F(AV)</sub>                                    | 2 x 30 A       |  |  |  |  |
| $V_{RRM}$   | 200 V          |  |  |  |  |
| I <sub>FSM</sub>                                      | 350 A          |  |  |  |  |
| $V_F$ at $I_F = 30 \text{ A } (T_J = 125 \text{ °C})$ | 0.65 V         |  |  |  |  |
| T <sub>J</sub> max.                                   | 175 °C         |  |  |  |  |
| Package   | TO-247AD 3L    |  |  |  |  |
| Circuit configuration                                 | Common cathode |  |  |  |  |

#### **FEATURES**

- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses
- · High efficiency operation
- Solder bath temperature 275 °C maximum, 10 s per JESD 22-B106
- AEC-Q101 qualified
  - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **TYPICAL APPLICATIONS**

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection in commercial, industrial, and automotive application.

#### **MECHANICAL DATA**

Case: TO-247AD 3L

Molding compound meets UL 94 V-0 flammability rating halogen-free, RoHS-compliant Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 1A whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: as marked

Mounting torque: 10 in-lbs maximum

| MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)          |            |                               |             |      |  |  |
|--|------------|-------------------------------|-------------|------|--|--|
| PARAMETER  |            | SYMBOL                        | VX60202PW   | UNIT |  |  |
| Maximum repetitive peak reverse voltage                                  |            | $V_{RRM}$                     | 200         | V    |  |  |
| Maximum average forward rectified current (fig. 1)                       | per device | I <sub>F(AV)</sub>            | 60          | Α    |  |  |
|  | per diode  |                               | 30          |      |  |  |
| Peak forward surge current 8.3 ms single half superimposed on rated load | sine-wave  | I <sub>FSM</sub>              | 350         | А    |  |  |
| Operating junction temperature range                                     |            | T <sub>J</sub> <sup>(1)</sup> | -40 to +175 | °C   |  |  |
| Storage temperature range  |            | T <sub>STG</sub>              | -40 to +175 |      |  |  |

(1) The heat generated must be less than the thermal conductivity from junction-to-ambient: dP<sub>D</sub>/dT<sub>J</sub> < 1/R<sub>8,IA</sub>



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| <b>ELECTRICAL CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise noted) |                        |                         |                               |       |      |      |
|---|------------------------|-------------------------|-------------------------------|-------|------|------|
| PARAMETER   | TEST CONDITIONS        |                         | SYMBOL                        | TYP.  | MAX. | UNIT |
|   | I <sub>F</sub> = 5 A   |                         | V <sub>F</sub> <sup>(1)</sup> | 0.61  | -    | V    |
|   | I <sub>F</sub> = 15 A  | $T_J = 25  ^{\circ}C$   |                               | 0.72  | -    |      |
| Instantanceus ferward voltage per diade   | I <sub>F</sub> = 30 A  |                         |                               | 0.79  | 0.84 |      |
| Instantaneous forward voltage per diode   | I <sub>F</sub> = 5 A   | T <sub>J</sub> = 125 °C |                               | 0.47  | -    |      |
|   | I <sub>F</sub> = 15 A  |                         |                               | 0.57  | -    |      |
|   | I <sub>F</sub> = 30 A  |                         |                               | 0.65  | 0.71 |      |
|   | V <sub>R</sub> = 160 V | T <sub>J</sub> = 25 °C  | I <sub>R</sub> <sup>(2)</sup> | 0.002 | -    | mA   |
| Reverse current at rated V <sub>R</sub> per diode                                 | v <sub>R</sub> = 160 v | T <sub>J</sub> = 125 °C |                               | 3.7   | -    |      |
|   | V 000 V                | T <sub>J</sub> = 25 °C  |                               | -     | 0.2  |      |
|   | V <sub>R</sub> = 200 V | T <sub>J</sub> = 125 °C |                               | 8.5   | 40   |      |
| Typical junction capacitance  | 4.0 V, 1 MHz           |                         | CJ                            | 2800  | -    | pF   |

#### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

(2) Pulse test: Pulse width ≤ 5 ms

| THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted) |                                 |     |      |  |  |  |
|---|---------------------------------|-----|------|--|--|--|
| PARAMETER   | PARAMETER SYMBOL VX60202PW UNIT |     |      |  |  |  |
| Typical thermal resistance per device                                   | $R_{\theta JC}$                 | 0.6 | °C/W |  |  |  |

| ORDERING INFORMATION (Example) |                 |              |               |               |  |
|--------------------------------|-----------------|--------------|---------------|---------------|--|
| PREFERRED P/N                  | UNIT WEIGHT (g) | PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |  |
| VX60202PW-M3/P                 | 5.64            | Р            | 25/tube       | Tube          |  |
| VX60202PWHM3/P (1)             | 5.64            | Р            | 25/tube       | Tube          |  |

#### Note

(1) AEC-Q101 qualified

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### RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

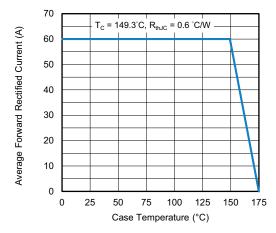


Fig. 1 - Maximum Forward Current Derating Curve

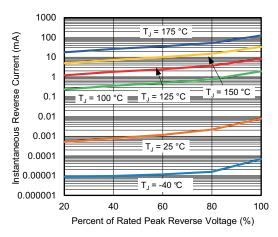


Fig. 4 - Typical Reverse Leakage Characteristics

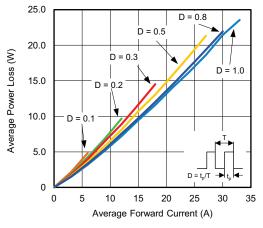


Fig. 2 - Average Power Loss Characteristics

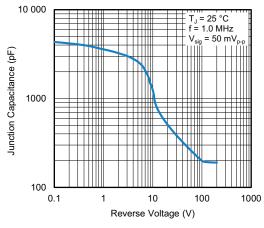


Fig. 5 - Typical Junction Capacitance

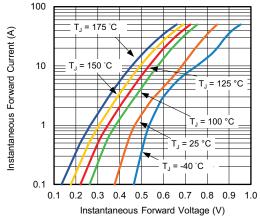


Fig. 3 - Typical Instantaneous Forward Characteristics

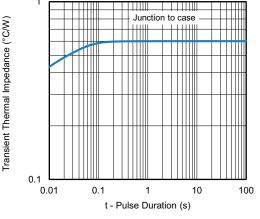
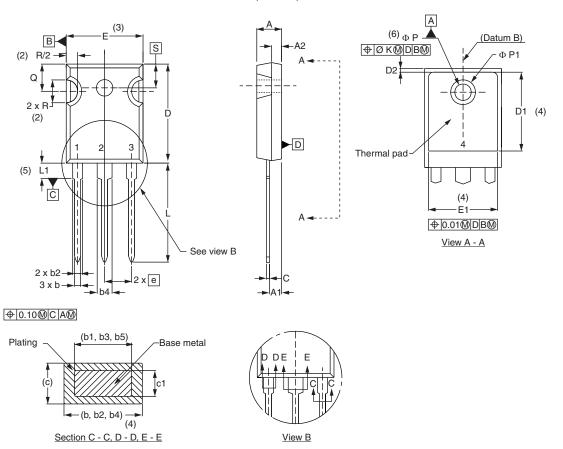


Fig. 6 - Typical Transient Thermal Impedance



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### PACKAGE OUTLINE DIMENSIONS in millimeters (inches) TO-247AD 3L



| SYMBOL  | MILLIMETERS |       | INC   | NOTES |       |
|---------|-------------|-------|-------|-------|-------|
| STWIBOL | MIN.        | MAX.  | MIN.  | MAX.  | NOTES |
| Α       | 4.65        | 5.31  | 0.183 | 0.209 |       |
| A1      | 2.21        | 2.59  | 0.087 | 0.102 |       |
| A2      | 1.50        | 2.49  | 0.059 | 0.098 |       |
| b       | 0.99        | 1.40  | 0.039 | 0.055 |       |
| b1      | 0.99        | 1.35  | 0.039 | 0.053 |       |
| b2      | 1.65        | 2.39  | 0.065 | 0.094 |       |
| b3      | 1.65        | 2.34  | 0.065 | 0.092 |       |
| b4      | 2.59        | 3.43  | 0.102 | 0.135 |       |
| b5      | 2.59        | 3.38  | 0.102 | 0.133 |       |
| С       | 0.38        | 0.89  | 0.015 | 0.035 |       |
| c1      | 0.38        | 0.84  | 0.015 | 0.033 |       |
| D       | 19.71       | 20.70 | 0.776 | 0.815 | 3     |
| D1      | 13.08       | -     | 0.515 | -     | 4     |

| SYMBOL  | MILLIN   | IETERS | INC   | NOTES |       |
|---------|----------|--------|-------|-------|-------|
| STWIDOL | MIN.     | MAX.   | MIN.  | MAX.  | NOTES |
| D2      | 0.51     | 1.30   | 0.020 | 0.051 |       |
| E       | 15.29    | 15.87  | 0.602 | 0.625 | 3     |
| E1      | 13.46    | -      | 0.53  | -     |       |
| е       | 5.46     | BSC    | 0.215 | BSC   |       |
| ØК      | 0.2      | 254    | 0.0   | )10   |       |
| L       | 19.81    | 20.32  | 0.780 | 0.800 |       |
| L1      | 3.71     | 4.29   | 0.146 | 0.169 |       |
| ØΡ      | 3.56     | 3.66   | 0.14  | 0.144 |       |
| Ø P1    | -        | 6.98   | -     | 0.275 |       |
| Q       | 5.31     | 5.69   | 0.209 | 0.224 |       |
| R       | 4.52     | 5.49   | 0.178 | 0.216 |       |
| S       | 5.51 BSC |        | 0.217 | BSC   |       |
|         |          |        |       |       |       |

#### **Notes**

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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